

RGP15A THRU RGP15M

FAST SWITCHING RECTIFIERS

GLASS PASSIVATED JUNCTION

Reverse Voltage – 50 to 1000 Volts

Forward Current – 1.5 Amperes

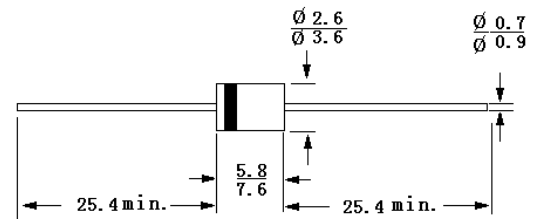
Features

- High temperature metallurgically bonded construction
- Cavity-free glass passivated junction.
- 1.5 Ampere operation at $T_A = 55^\circ\text{C}$ with no thermal runaway.
- Typical I_R less than $0.1\mu\text{A}$
- High temperature soldering guaranteed:
350°C/10seconds, 0.375" (9.5mm) lead length,
5 lbs. (2.3kg) tension

Mechanical Data

- **Case:** JEDEC DO-204AC, molded plastic over glass body.
- **Terminals:** Plated axial leads, solderable per MIL-STD-750, Method 2026
- **Polarity:** Color band denotes cathode end
- **Mounting Position:** Any

DO-15



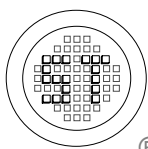
Dimensions in mm

Absolute Maximum Ratings and Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

	Symbols	RGP 15A	RGP 15B	RGP 15D	RGP 15G	RGP 15J	RGP 15K	RGP 15M	Units
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current 0.375" (9.5mm) lead length at $T_A = 55^\circ\text{C}$	$I_{F(AV)}$	1.5							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	50							A
Maximum full load reverse current, full cycle average 0.375" (9.5mm) lead length at $T_A = 55^\circ\text{C}$	$I_{R(AV)}$	100							μA
Maximum instantaneous forward voltage at 1.5A	V_F	1.3							V
Maximum DC reverse current $T_A = 25^\circ\text{C}$ at rated DC blocking voltage $T_A = 150^\circ\text{C}$	I_R	5 200							μA μA
Maximum reverse recovery time $I_F=0.5\text{A}$, $I_R=1\text{A}$, $I_{rr}=0.25\text{A}$.	T_{rr}	150				250	500		nS
Typical junction capacitance at 4 V, 1MHz	C_J	25							pF
Typical thermal resistance (Note 1)	$R_{\theta JA}$	45							$^\circ\text{C/W}$
Operating junction and storage temperature range	T_J, T_S	-65 to +175							$^\circ\text{C}$

Notes:1. Thermal resistance from junction to ambient at 0.375" (9.5mm) lead length, P.C.B.mounted.



SEMTECH ELECTRONICS LTD.

(Subsidiary of Semtech International Holdings Limited, a company listed on the Hong Kong Stock Exchange, Stock Code: 724)



ISO/TS 16949 : 2002
Certificate No. 05103



ISO 14001
Certificate No. 7116



ISO 9001 : 2000
Certificate No. 550-159-04-002-04

Dated : 20/06/2003

RGP15A THRU RGP15M

RATINGS AND CHARACTERISTIC CURVES ($T_A=25^{\circ}\text{C}$ unless otherwise noted)

FIG.1-FORWARD CURRENT DERATING CURVE

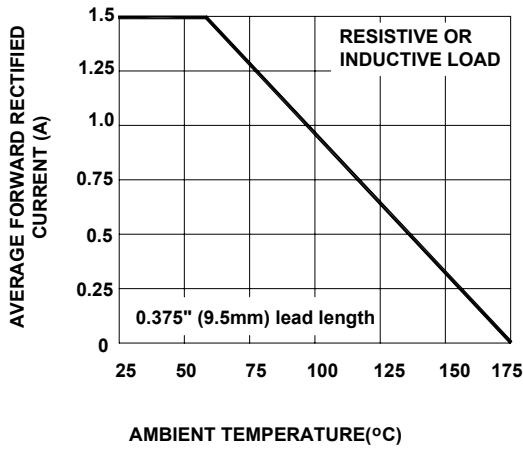


FIG.2-MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

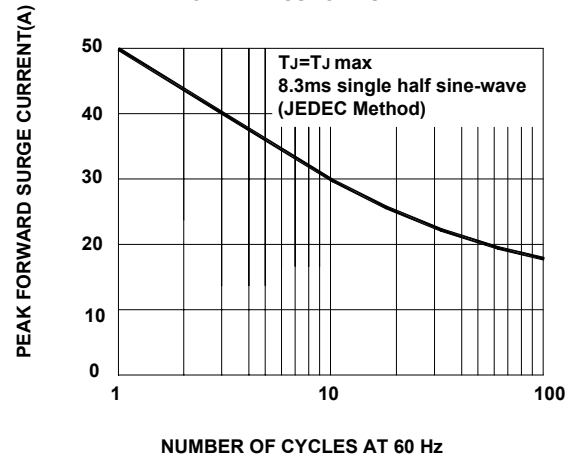


FIG.3-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

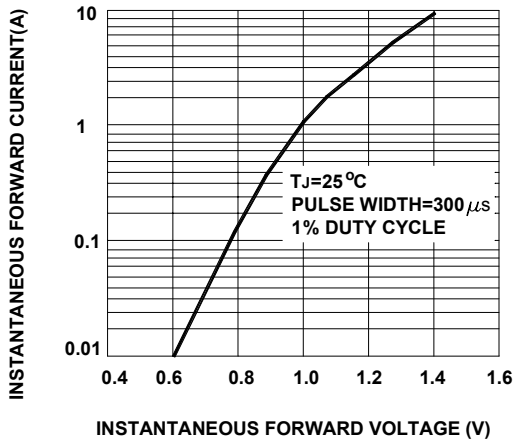


FIG.4-TYPICAL REVERSE CHARACTERISTICS

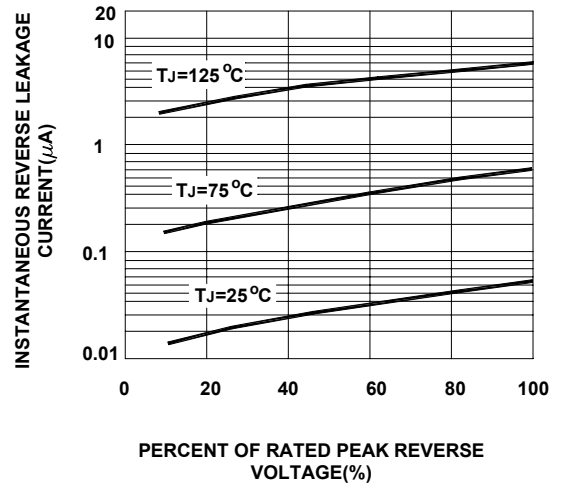


FIG.5-TYPICAL JUNCTION CAPACITANCE

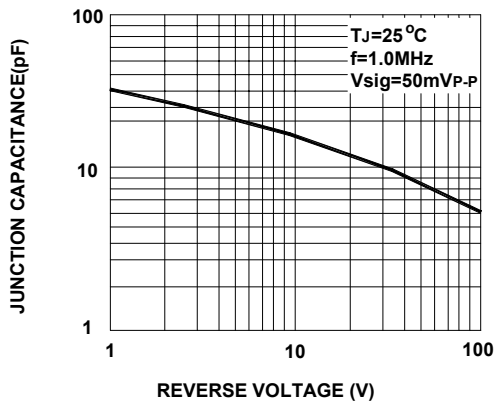
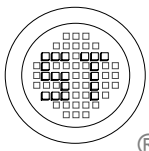
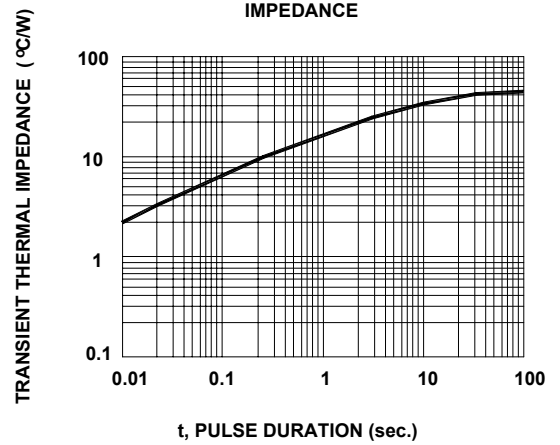
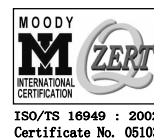


FIG.6-TYPICAL TRANSIENT THERMAL IMPEDANCE



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